

# PATENT SPECIFICATION

1,080,107

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## COMPLETE SPECIFICATION

### DRAWINGS ATTACHED

#### A Method of Producing a Pattern on a Surface

WE, INTERNATIONAL BUSINESS MACHINES CORPORATION, a Corporation organized and existing under the laws of the State of New York in the United States of America, of Armonk, New York 10504, United States of America (assignees of Leonard James Reed, and John R. Morrison), do hereby declare the invention for which we pray that a patent may be granted to us, and the method by which it is to be performed, to be particularly described in and by the following statement:—

This invention relates to a process for producing line patterns, particularly patterns composed of very fine lines, such as are found in micro-miniature circuitry. The previously employed techniques generally involve either etching or silk screening. These two methods have been extended to their limits, as far as resolution and minimum line width are concerned.

According to the invention we provide a method of producing a pattern on a surface comprising the steps of generating a magnetic line replica of the pattern on a magnetisable support, before or after covering said support with an electrically insulating layer, and developing said magnetic line replica on said insulating layer by bringing the latter into contact with fine magnetic particles.

A preferred embodiment of the invention uses as a support a ferromagnetic element having substantial retentivity, such as the coating of a magnetic tape of the type used in the data processing art for storing information. In a surface zone of the ferromagnetic element, for example in the magnetic oxide coating of a magnetic tape, a magnetic line replica of the desired pattern is formed, for example by means of a magnetic probe capable of generating at the surface of the ferromagnetic element a

field of such smallness of cross section as is required for the particular pattern. While producing no visible effect upon the ferromagnetic element, the field of the probe, where it intersects the ferromagnetic material, magnetizes the material in the line along which the probe is drawn, forming a magnetic line replica of the pattern to be formed, which replica is developed by immersion in a magnetic colloid. When the replica is sufficiently developed it is generally plated, to improve its properties, for example, with a metal, to develop desired electrical properties. The insulating layer, with its developed, and generally plated replica may then be removed from the ferromagnetic element and is ready for use. The ferromagnetic element, with its original magnetic line replica, can then be used to make duplicate patterns, by repeating the process from the point of covering the ferromagnetic element with an insulating layer. In some cases the insulating layer, with its replica, may be left on the ferromagnetic element. This variation of the process is used particularly when an inexpensive ferromagnetic element, such as magnetic oxide tape, is used and duplicate patterns are not to be made by preserving the originally generated magnetic line pattern in the ferromagnetic element.

In order that the invention may be well understood, embodiments thereof will be described in detail, with reference to the accompanying drawing, in which:

Figure 1 is a perspective diagrammatic view of a ferromagnetic element illustrating the first step of the process;

Figure 2 is a diagrammatic side elevation of the ferromagnetic element showing a facsimile of the pattern at a later stage of the process;

Fig. 3 is a plan view of the ferromagnetic

[Price 4s. 6d.]

element with pattern at the same stage as shown in Fig. 2;

Fig. 4 is a diagrammatic vertical section of an electromagnetic probe, such as can be used to generate a magnetic line pattern in the surface layer of the ferromagnetic element;

Fig. 5A-L is a group of diagrams in side elevation and plan view showing successive stages in the process of manufacturing a magnetic memory, in accordance with the invention.

Referring now to Figs. 1-3, illustrating one process according to the invention, a ferromagnetic element is shown, in this case composed of a piece of magnetic oxide tape of the type used in data processing, comprising a magnetic oxide coating 12 on a plastic base 10. The coating is characterized by substantial retentivity, that is to say, when subjected to a magnetic field of sufficient strength it will be permanently magnetized where the field intersects it. As indicated in this figure, the field may be generated by a magnetic probe 14 having the general design shown, on an enlarged scale, in Fig. 4. A central ferromagnetic wire 16 is wrapped by a winding 18 having terminals by which a D.C. current can be passed through it. The core 16 is sheathed in an electrically insulating layer 20, preferably applied by electroless plating. The sheath 20 is then plated with more ferromagnetic material 22. The end of the circular probe is lapped off to an angle of 80°, to provide a sharp-pointed end which will generate a magnetic field, when the coil 18 is energized, extending between the core 16 and shell 22 across the gap formed by the insulator 20. Because the gap is formed by the plated insulator, it can be made smaller than that of conventional recording heads (by limiting the plating time); that is, less than 50 ". Gaps approximately as small as 10 " have been made. The ferromagnetic layer plated over the insulator is also less than 50 ". When the end of the probe has been lapped as shown in point 28 of the outer ferromagnetic layer is in the low " range in width, that is, less than 10 ". Since it is the flux gradient exterior to the probe that does the writing, and the flux is concentrated by the pointed configuration of the end of the probe, the effective writing cross section of the flux is less than the physical geometry of the gap or probe and may write in line less than 5 " in width.

If the pattern to be produced is a micro-miniature circuit, for example, the movement of the probe is preferably accomplished by mounting it on a head which can be programmed for travel along two coordinate axes. Recorders of this type are well known and have not been shown in

the drawings. When the probe has completed its movement over the surface of the ferromagnetic element the magnetic flux intersecting the surface of the layer 12 will have left in the surface portion a pattern of very fine magnetized lines, such as 30 forming a replica of the desired circuit.

The layer 12 is now covered with an insulating layer 32 (Figure 2). Since, in the process being described, this layer will later be removed from the magnetic tape, it is preferably an extremely thin plastic layer, of the type commercially available under the Registered Trade Mark "Saran Wrap," which has the advantage that it adheres tightly to the magnetic tape when laid upon it. Alternatively, the magnetic coating of the tape can be covered with a thin film of vaseline and a strip of another commercially known plastic sheet sold under the Registered Trade Mark "Mylar" laid upon it. Other means for covering a ferromagnetic material with an insulating coating can be used, so long as the coating will remain in a fixed position on the ferromagnetic member during the further steps of the process to be described.

The next step is to develop the magnetic lines of the pattern, by bringing the insulating layer into contact with magnetic particles. The preferred way of performing this step is to submerge the sandwich of ferromagnetic element and insulating coating in a magnetic colloid. A suitable colloid for this purpose is one described by Craik and Griffiths in British Journal of Applied Physics, Man., 280 (1958). When a thin visible line 34 of magnetic material deposited from the colloid has formed on the layer 12 the sandwich is removed from the colloid. The line 34 appears continuous, when viewed under the microscope, but generally it is desirable to improve its properties by plating another substance onto it, as shown at 36, generally a metal, to improve both the physical and electrical properties of the lines forming the replica of the desired circuit pattern.

The plating may be done by either an electroless or electroplating operation. For electroless or chemical deposition of copper, for example, a typical plating solution would be:

Rochelle salt	13.3	oz./gal.	
copper sulfate	4	oz./gal.	120
caustic soda	5.3	oz./gal.	
Formaldehyde (37%)	4	oz./gal.	
condition: at room temperature.			

Other metals, such as silver and gold, can be plated on by chemical deposition in a similar way.

A still greater variety of deposits can be achieved by electroplating. For example, a typical copper electrodeposition solution would be:

130

copper sulfate 33.0 oz./gal.  
 sulfuric acid 1.5 oz./gal.  
 thiourea .0001 oz./gal.  
 wetting agent .027 oz./gal.  
 5 Operating conditions: Temp. 60-120°F.  
 Current density—20 amperes per sq. ft.  
 of area.

When the desired physical properties of the pattern have been achieved the insulating layer can be stripped off of the ferromagnetic substrate and prepared for use by any desired additional steps.

If a duplicate replica is to be made the process is repeated by covering the ferromagnetic element with another insulating layer and proceeding as above-described. Since the original magnetic line replica remains in the ferromagnetic element it can be developed on the new insulating layer as before. The process can be repeated indefinitely.

In the process just described it is evident that one may start by initially placing on the ferromagnetic element an insulating layer and then drawing a line with the magnetic probe to form a replica of a pattern.

As another example of utilization of the process there will now be described a method of making a memory plane of the type used in magnetic storage memories for data processing machines. One form of such a memory plane comprises a substrate on which are placed thin film dots of ferromagnetic material having special magnetic properties, the dots being arranged in a matrix consisting of rows and columns. Extending over each row of thin film dots is a conductor called a horizontal drive line; over each column of dots extends a conductor called a vertical drive line. The two sets of drive lines are insulated from each other so that electric currents can be passed through individual pairs of one horizontal and one vertical drive line, selectively, for producing effects by magnetic induction in selected ones of the thin film dots. It is such a thin film memory plane that will be produced by the process about to be described, with reference to Figure 5 A-L. In this figure there is a pair of views, namely, a side-elevational diagram and a plan view diagram, depicting the condition of the memory plane at various stages of the process. Starting with the stage depicted in views 5A and 5B, a magnetic tape comprising a plastic base 50 coated with a magnetic oxide layer 52 has placed upon the oxide layer an array of thin film magnetic dots 54. Only four dots are shown, but these are sufficient to illustrate the arrangement of the dots in horizontal rows and vertical columns. The actual number of dots in each row and each column will depend upon the design of the

memory plan to be produced.

Next, parallel lines are "written" in the magnetic oxide coating by passing a magnetic probe 14 along the tape so as to cross diametrically over the spots constituting the different horizontal rows. The flux from the probe will induce magnetic lines 56 in the oxide coating, continuous from end to end of each row, and a little beyond for termination. The extent to which the dots themselves will also be magnetized along the lines will depend upon the coercive force of the ferromagnetic material of which they are composed.

Turning now to views C and D, the next step is to place over the magnetic tape and thin film dots an insulating layer 58, forming a two-layer sandwich. This is conveniently done by evaporating silicon monoxide onto the entire surface. Instead of first writing the magnetic lines and then applying the insulating layer, these steps can be reversed in order. In either case, the next procedure is to develop the magnetic lines by bringing the surface of the layer 58 into contact with magnetic particles. Again, this is done most satisfactorily by submerging the sandwich in a magnetic colloid. The developed line then appears on the surface of the insulator, as shown at 60.

The next step, shown in views E and F, is to plate the developed lines 60, to produce the desired physical and electrical properties for the drive lines. The plated layers on the magnetic lines 60 are shown at 62. The horizontal drive lines are now complete. Next, the ferromagnetic oxide coating is demagnetized by applying an a-c field to it, so that there remain no magnetic lines.

Now vertical drive lines 64 are written onto the ferromagnetic oxide coating, as shown in views G and H, by passing the magnetic probe 14 over the vertical rows of dots. Either before or after this is done the whole surface is again coated with an insulating layer, for example by evaporating onto it silicon monoxide, as shown at 66 in the view I. Now the vertical magnetic lines are developed as shown at 68 in views I and J, by submerging the element in a magnetic colloid.

Finally, the physical properties of the developed vertical drive lines are improved, as shown in views K and L, by plating onto them a coating 70. Then all magnetic lines of the memory plane are erased.

The basic structure of the memory plane is now complete. Other electrical lines, such as sense windings, can be produced on the plane by following the same steps previously described. The whole plane can also be covered with any desired protective covering when its electrical structure has been completed.

The process of the invention has been illustrated by two examples. These can be multiplied without limit. It is evident that the process is characterized by great simplicity and economy, whether it utilizes the unlimited duplication of the first method described, or the progressive build-up of the second method.

WHAT WE CLAIM IS:—

- 10 1. A method of producing a pattern on a surface comprising the steps of generating a magnetic line replica of the pattern on a magnetisable support before or after covering said support with an electrically insulating layer, and developing said magnetic line replica on said insulating layer by bringing the latter into contact with fine magnetic particles.
- 20 2. A method as claimed in claim 1, wherein said magnetic line replica is generated by passing over the surface of the support a magnetic probe.
3. A method as claimed in claim 1 or claim 2 wherein said replica is developed on said insulating layer by bringing the latter into contact with a magnetic colloid.
- 25 4. A method as claimed in any preceding claim including the further step of electroplating the developed replica.
- 30 5. A method as claimed in any preceding claim, for producing a number of replicas of said pattern, including the further steps of stripping said insulating layer from said ferromagnetic element, covering said ferromagnetic element with a second insulating layer, developing said

magnetic line replica on said second insulating layer by bringing said second insulating layer into contact with fine magnetic particles, and repeating the process for as many replicas as are required.

6. A method as claimed in any preceding claim for producing a magnetisable film data storage device, comprising the steps of securing to a surface of an element having substantial retentivity thin film dots of a magnetisable film storage material, the dots being arranged in a matrix of rows and columns; generating a first set of continuous, parallel fine magnetic lines in a surface zone of said element, one line for each row of said dots, each line crossing all of the dots of its related row, covering the said element and the dots thereon with an insulating layer, developing said lines on said insulating layer by bringing said insulating layer into contact with fine magnetic particles, erasing said magnetic lines, generating a second set of continuous, parallel fine magnetic lines in said surface zone of said element, one line for each column of said dots, each of said second set of lines crossing all of the dots in its related column, covering said element with another insulating layer and developing said second set of magnetic lines on said other insulating layer by bringing the latter into contact with fine magnetic particles.

N. A. KILLGREN,  
Chartered Patent Agent,  
Agent for the Applicants.

FIG. 1

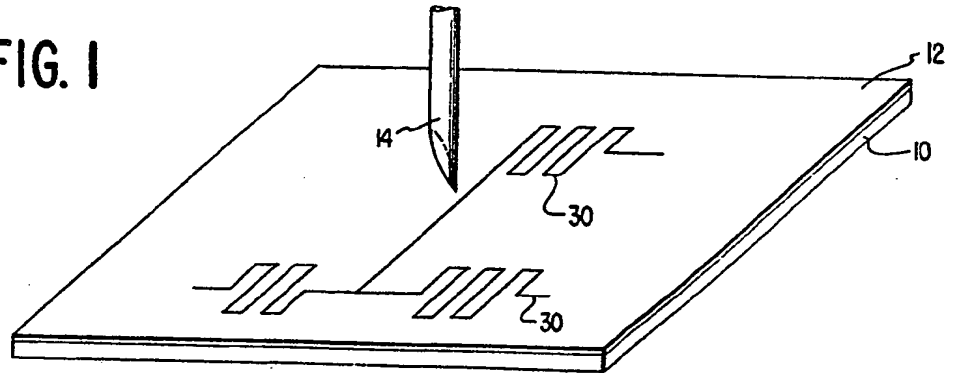


FIG. 2

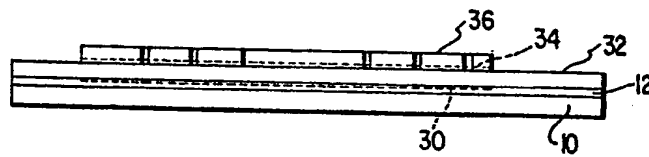


FIG. 3

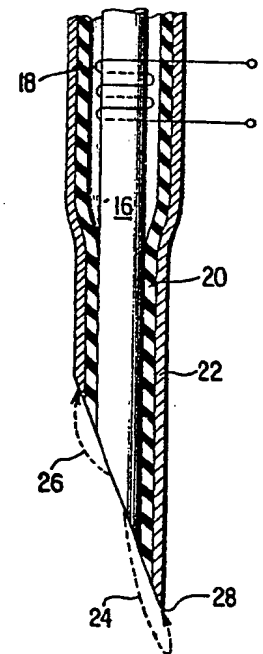
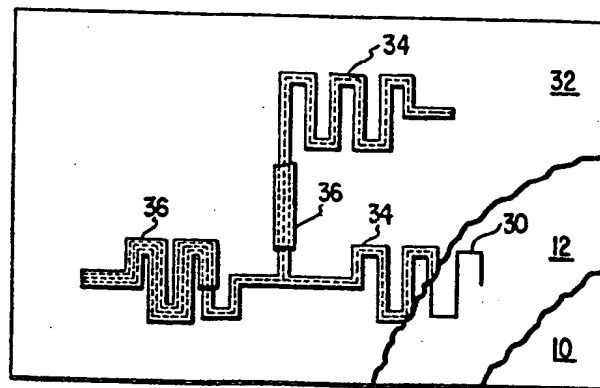


FIG. 4

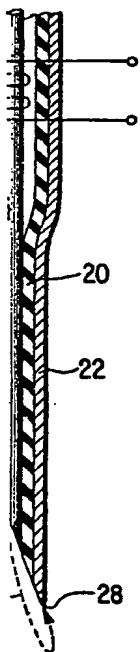
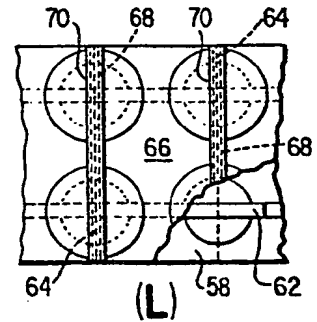
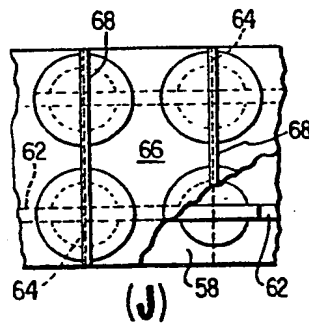
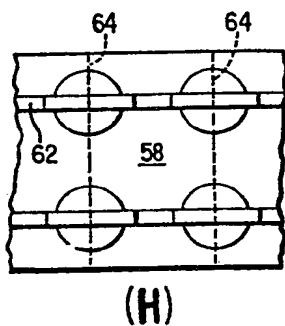
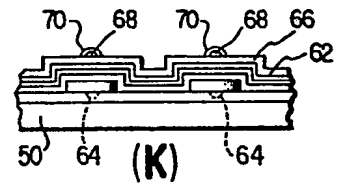
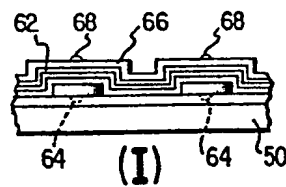
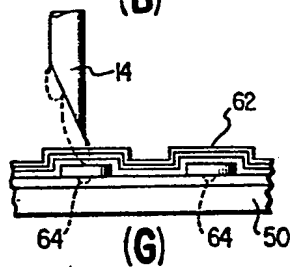
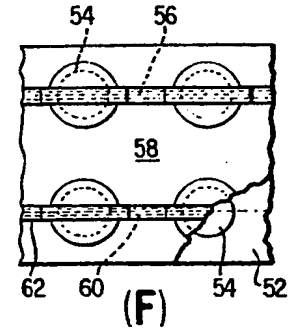
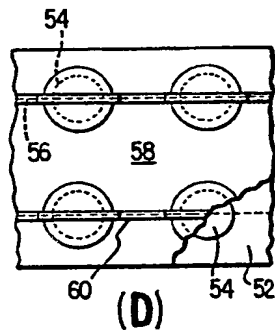
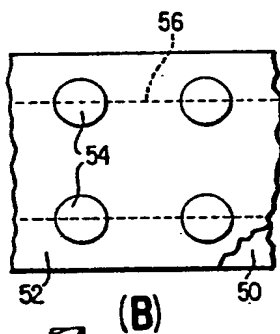
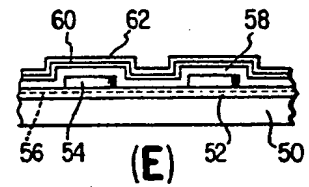
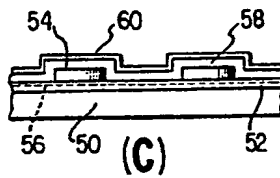
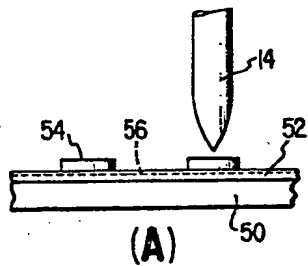
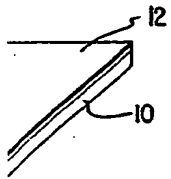
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2 SHEETS

COMPLETE SPECIFICATION

This drawing is a reproduction of  
the Original on a reduced scale.  
SHEETS 1 & 2

FIG. 5



4

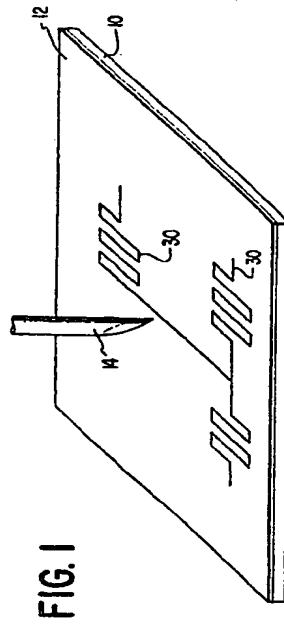


FIG. 1

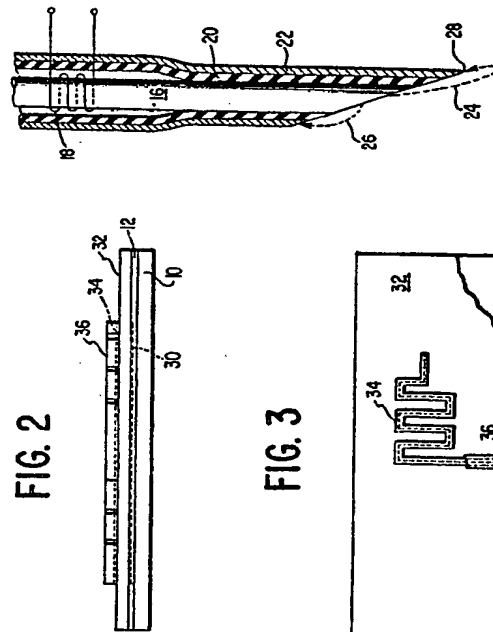


FIG. 2

FIG. 3

FIG. 4

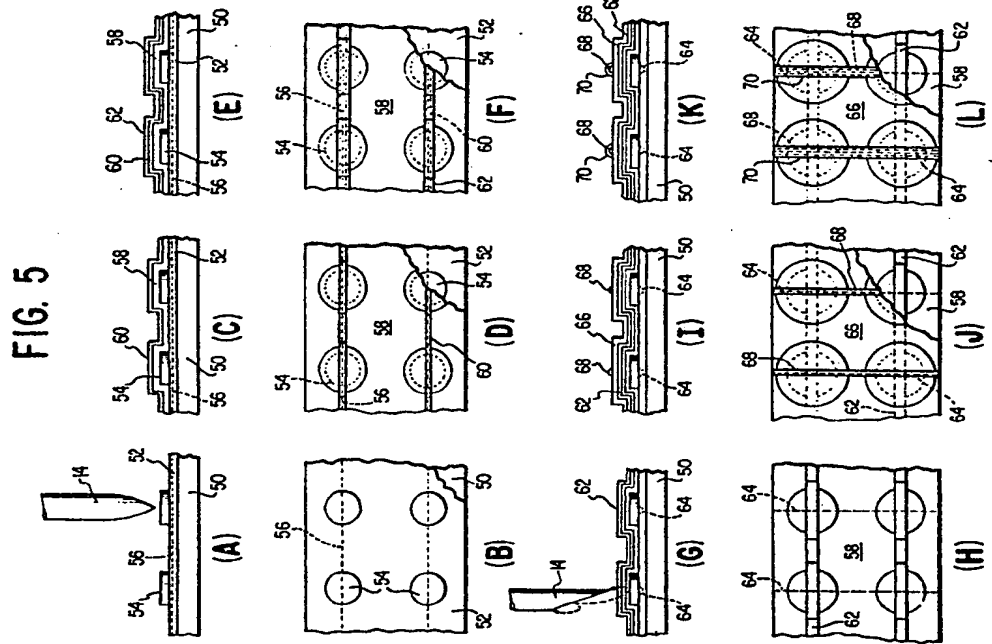


FIG. 5

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